Document Number: GTAH30050C6 Preliminary Datasheet V1.0

# GaN HEMT 28V, 50W, General purpose RF Power Transistor Description

The GTAH30050C6 is a 50W GaN HEMT, designed for multiple applications, up to 3GHz.

The transistor is available in a highly cost effective 10\*6mm, surface mount, QFN package with

100% DC production test to ensure the quality and consistency.

It can be used in CW, Pulse and any other modulation modes.

There is no guarantee of performance when this part is used in applications designed Outside of these frequencies.

Typical Class AB RF Performance with device soldered through high density and plated grounding vias
Vds = 28V, Idq = 45mA,Vgs=-2.6V

Freq	P1dB	P1dB	P1dB	P1dB	P3dB	P3dB	P3dB
(MHz)	(dBm)	(W)	Eff(%)	Gain(dB)	(dBm)	(W)	Eff(%)
2400	46.4	43.6	61.7	18.52	47.91	61.8	70.6
2450	45.62	36.5	60.0	18.6	47.53	56.6	71.2
2500	44.73	29.7	56.5	17.95	47.26	53.3	71.1

# Applications

- S band power amplifier
- L band power amplifier
- ISM/RF Energy power amplifier

# **Important Note: Proper Biasing Sequence for GaN HEMT Transistors**

#### Turning the device ON

# Turning the device OFF

- 1. Set VGS to the pinch--off (VP) voltage, typically –5 V 1. Turn RF power off
  - 2. Reduce VGS down to VP, typically -5 V
  - 3. Reduce VDS down to 0 V
  - 4. Turn off VGS

## Figure 1: Pin Connection definition

2. Turn on VDS to nominal supply voltage

Increase VGS until IDS current is attained
Apply RF input power to desired level

## Transparent top view (Backside grounding for source)

654	321
8	35
9	34
10	33
11]	[32]
12	31
13]	[30]
14	[29]
15	[28]
16	27
17	[26]
18	25
7 19 20 21	22 23 24

Pin No.	Symbol	Description
8,9,10,11,14,15,16,17	RF IN/Vgs	RF Input, Vgs bias
26,27,28,29,32,33,34,35	RF OUT/VDD	RFOutput, Drain bias





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Rest Pins and Package Base	GND	DC/RF Ground. Must be soldered directly to heatsink or copper coin for CW application.			
Table 1. Maximum Ratings					
Rating		Symbol	Value	Unit	
DrainSource Voltage		V <sub>DSS</sub>	+150	Vdc	
GateSource Voltage		V <sub>GS</sub>	-8 to +0.5	Vdc	
Operating Voltage		V <sub>DD</sub>	36	Vdc	
Maximum gate current		lgs	12	mA	
Storage Temperature Range		Tstg	-65 to +150	°C	
Case Operating Temperature		Tc	+150	°C	
Operating Junction Temperature		TJ	+225	°C	
Table 2. Thermal Characteristics		·			

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case by FEA	Rejc	2.5	°C /W
T <sub>c</sub> = 85°C, at Pdiss=25W		2.5	

## Table 3. Electrical Characteristics (TA = 25°C unless otherwise noted)

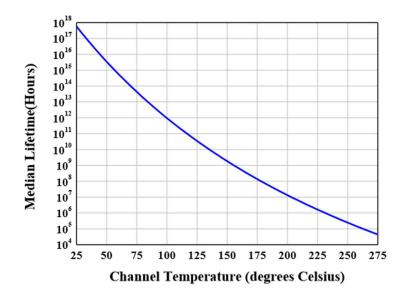
### DC Characteristics (main path, measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS=12mA	V <sub>DSS</sub>		200		V
Gate Threshold Voltage	VDS =10V, ID = 12mA	V <sub>GS(th)</sub>	-4		-2	V
Gate Quiescent Voltage	cent Voltage VDS =28V, IDS=45mA, Measured in Functional Test			-2.6		V

#### **Ruggedness Characteristics**

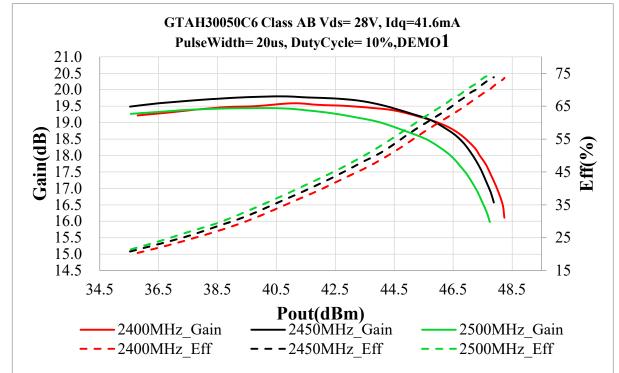
Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Load mismatch capability	2.5GHz, Pout=50W Pulsed CW					
	All phase, VSWR			10:1		
	No device damages					

#### Figure 2: Median Lifetime vs. Channel Temperature



## Typical performance

#### Figure 3: Efficiency and power gain as function of Pout





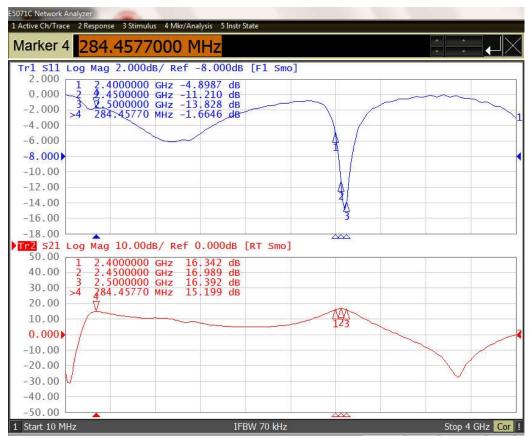
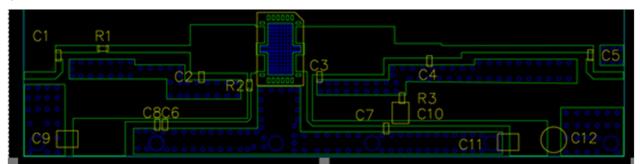


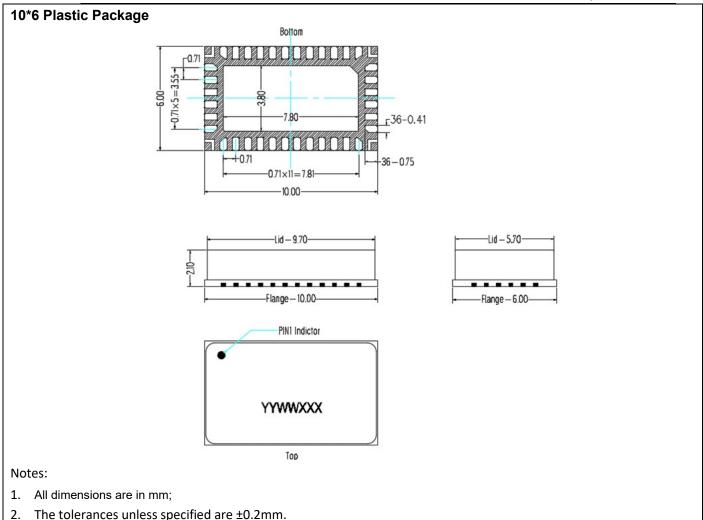
Figure 5: Picture of application board



## Table 4. Bill of materials of application board (PCB layout upon request, RO4350B 20mils)

Component	Value	Quantity
U1	GTAH30050C6	1
C1	5.1pF	1
C5、C6、C7	12pF	3
C8	10uF/16V	1
C9、C10、C11	10uF/63V	3
R1、R2、R3	10 Ω	3
C12	470uF/63V	1
C2	2pF	1
C3	0.8pF	1
C4	0.5pF	1

#### Document Number: GTAH30050C6 Preliminary Datasheet V1.0



# **Revision history**

Table 4. Document revision history

Date	Revision	Datasheet Status
2023/11/8	V1.0 Preliminary Datasheet Creation	

#### Application data based on: ZYX-23-11

## Notice

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